Qualcomm

RF360
Europe GmbH

Data sheet

SAW diplexer

Automotive telematics
TD-SCDMA bands 34 & 39

Series/type:	B4384
Ordering code:	B39202B4384P810
Date:	November 08, 2019
Version:	2.1

DCN: 80-PA243-171 Rev. A

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1 Application

- Low-loss 2in1 RF filter for TD-SCDMA band 34 and TD-SCDMA band 39 systems
- TD-SCDMA B34: 15MHz
- TD-SCDMA B39: 40MHz
- Low amplitude ripple

2 Features

- Package size $1.5_{\pm 0.1}$ mm × $1.1_{\pm 0.1}$ mm
- Package height 0.45 mm (max.)
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 3: −40 °C to +85 °C)

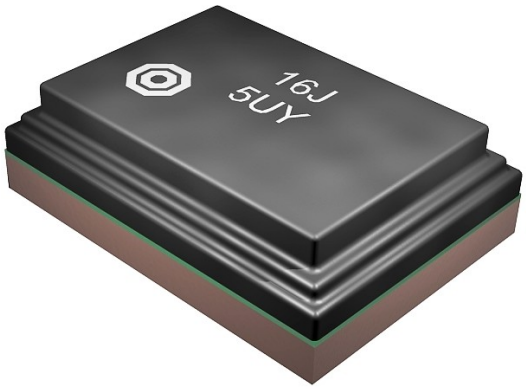

Figure 1: Picture of component with example of product marking.

3 Package

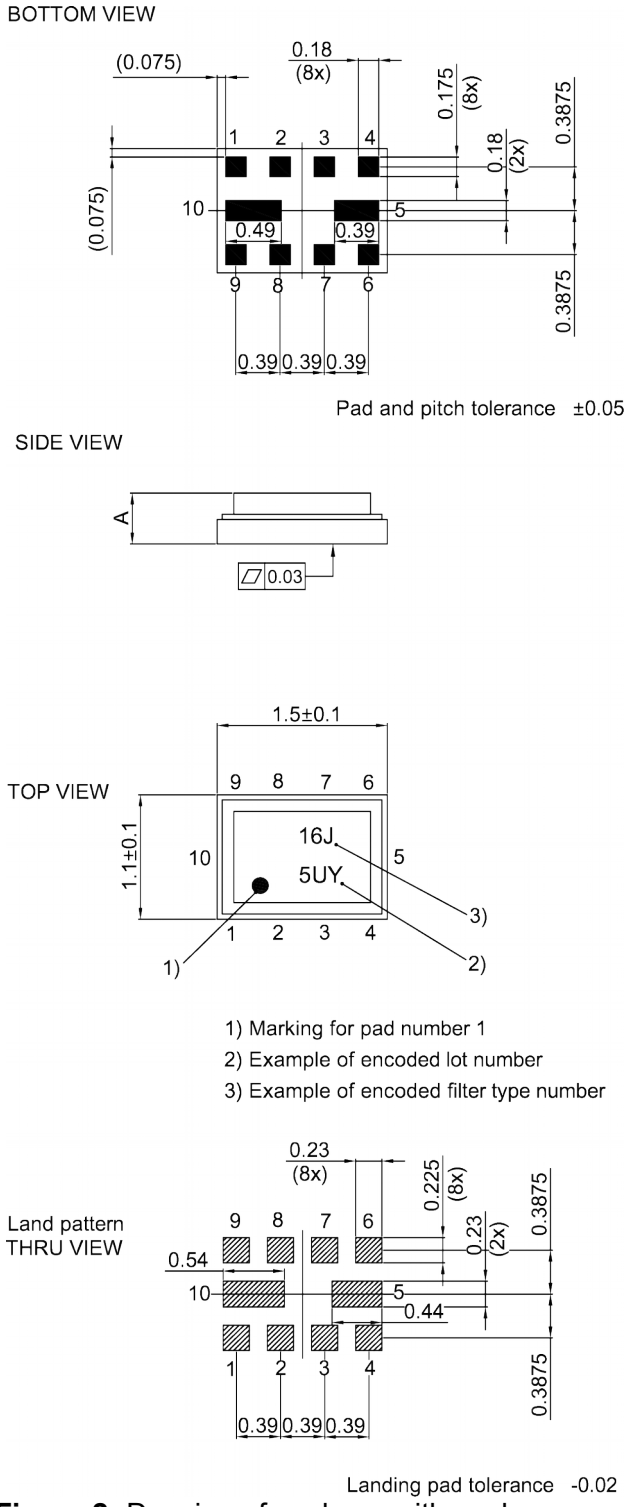

Figure 2: Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 20).

4 Pin configuration

- 1 Input (B34 & B39)
- 6 Output (B34)
- 9 Output (B39)
- 2, 3, 4, 5, 7, 8, 10 Ground

5 Matching circuit

- L_{p1} = 4.6 nH

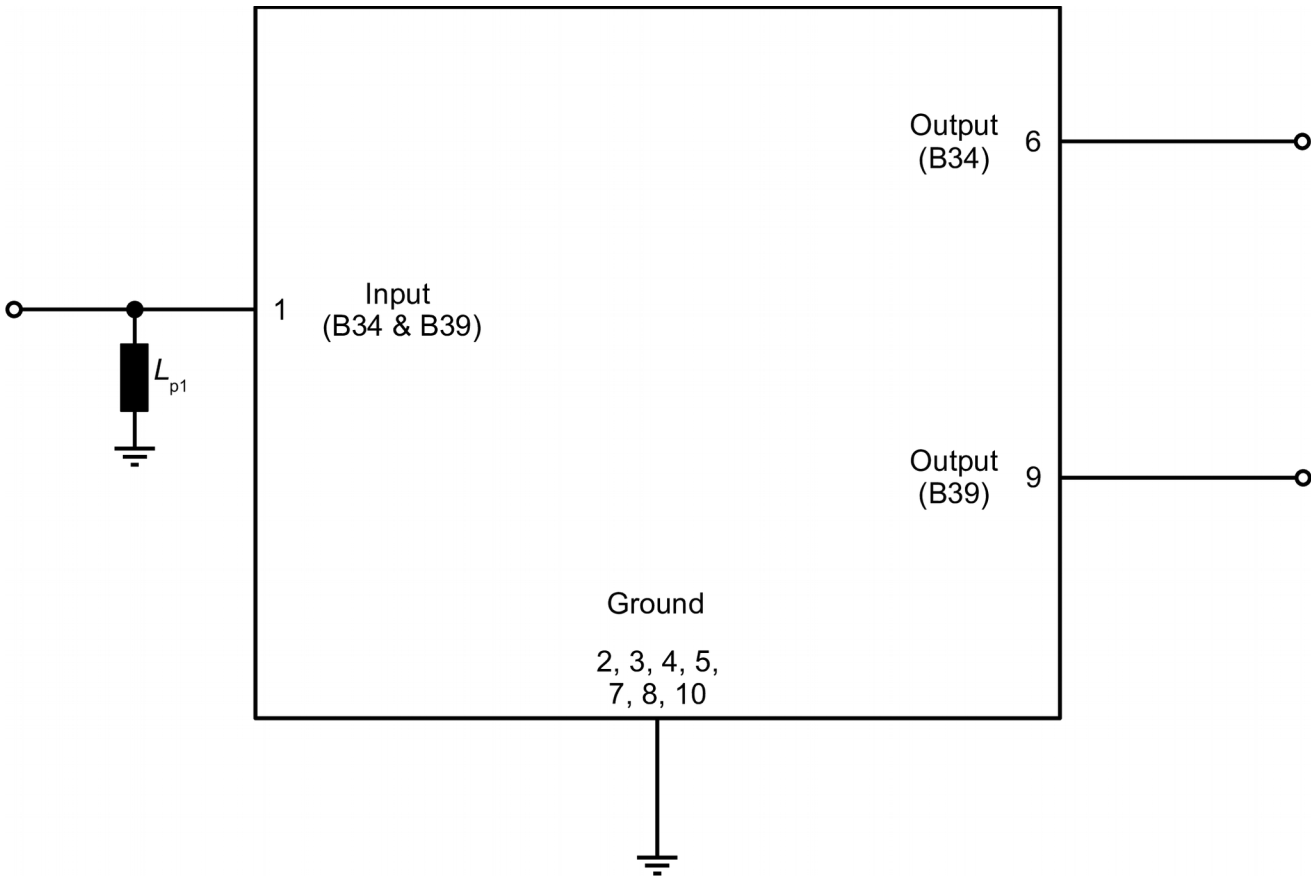

Figure 3: Schematic of matching circuit.

6 Characteristics TD-SCDMA B34

Temperature range for specification T_{SPEC} = −30 °C ... +85 °C
Input terminating impedance Z_{IN} = 50 Ω // 4.6 nH[1)]
B34 output terminating impedance $Z_{B34\ OUT}$ = 50 Ω
B39 output terminating impedance $Z_{B39\ OUT}$ = 50 Ω

Characteristics TD-SCDMA B34				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	2017.5	—	MHz
Maximum insertion attenuation			α_{max}				
	2010... 2025	MHz		—	1.7	2.3	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	2010... 2025	MHz		—	0.4	0.9	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	2010... 2025	MHz		—	1.4	1.9	
@ B34 output port	2010... 2025	MHz		—	1.4	1.9	
Minimum attenuation			α_{min}				
	50... 1000	MHz		35	38	—	dB
	1000... 1850	MHz		30	34	—	dB
	1850... 1930	MHz		33	38	—	dB
	1930... 1950	MHz		30	35	—	dB
	1950... 1980	MHz		7	18	—	dB
	2050... 2075	MHz		2.8	10	—	dB
	2075... 2100	MHz		27	33	—	dB
	2100... 2800	MHz		33	38	—	dB
	2800... 4100	MHz		35	40	—	dB
	4100... 4900	MHz		29	36	—	dB
	4900... 6000	MHz		23	30	—	dB

[1)] See Sec. Matching circuit (p. 6).

7 Characteristics TD-SCDMA B39

Temperature range for specification T_{SPEC} = −30 °C ... +85 °C
Input terminating impedance Z_{IN} = 50 Ω // 4.6 nH[1)]
B34 output terminating impedance $Z_{B34\ OUT}$ = 50 Ω
B39 output terminating impedance $Z_{B39\ OUT}$ = 50 Ω

Characteristics TD-SCDMA B39				**min.** for T_{SPEC}	**typ.** @ +25 °C	**max.** for T_{SPEC}	
Center frequency			f_C	—	1900	—	MHz
Maximum insertion attenuation			α_{max}				
	1880... 1920	MHz		—	1.9	2.4	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	1880... 1920	MHz		—	0.6	1.2	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	1880... 1920	MHz		—	1.6	2.0	
@ B39 output port	1880... 1920	MHz		—	1.7	2.0	
Minimum attenuation			α_{min}				
	50... 925	MHz		31	34	—	dB
	925... 960	MHz		31	34	—	dB
	960... 1805	MHz		25	29	—	dB
	1805... 1840	MHz		27	35	—	dB
	1840... 1850	MHz		26	34	—	dB
	1982... 2005	MHz		28	32	—	dB
	2005... 2800	MHz		28	33	—	dB
	2800... 3700	MHz		32	38	—	dB
	3700... 5400	MHz		20	27	—	dB
	5400... 6000	MHz		16	24	—	dB

1) See Sec. Matching circuit (p. 6).

8 Maximum ratings

Operable temperature	T_{OP} = −40 °C ... +85 °C	
Storage temperature	T_{STG} [1] = −40 °C ... +85 °C	
DC voltage	$\lvert V_{DC} \rvert$ [2] = 0 V (max.)	
Input power	P_{IN}	
@ input port: 1880 ... 1920 MHz	10 dBm	Continuous wave for 100000 h @ 85 °C.
@ input port: 2010 ... 2025 MHz	10 dBm	Continuous wave for 100000 h @ 85 °C.

1) Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.
2) In case of applied DC voltage blocking capacitors are mandatory.

9 Transmission coefficient TD-SCDMA B34

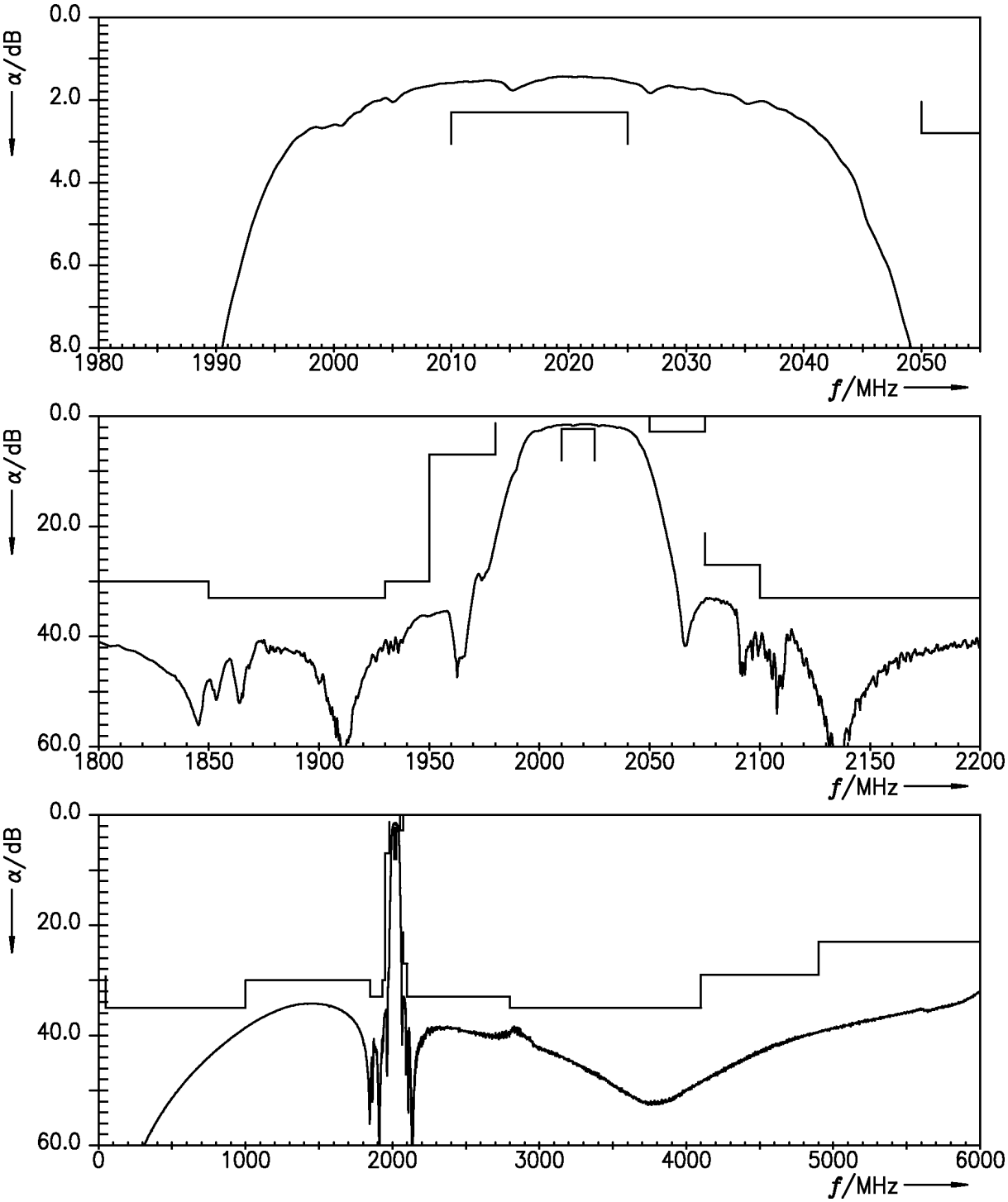

Figure 4: Attenuation TD-SCDMA B34.

10 Reflection coefficients TD-SCDMA B34

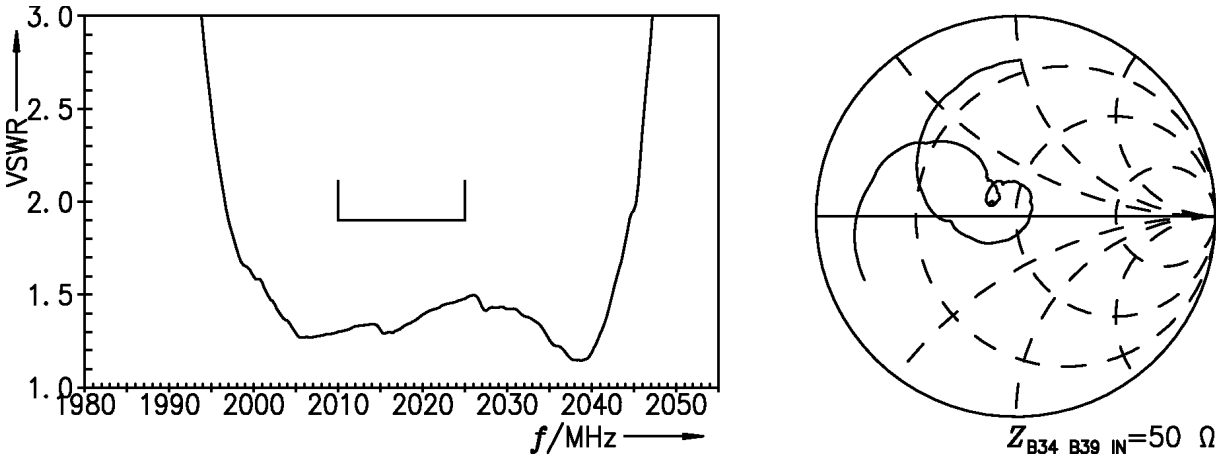

Figure 5: Reflection coefficient at input port.

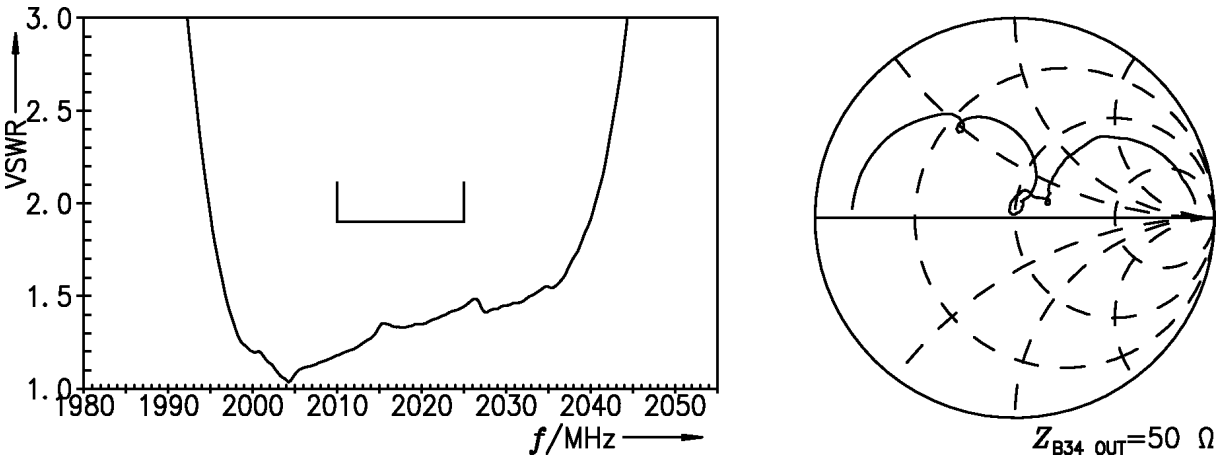

Figure 6: Reflection coefficient at B34 OUT port.

11 Transmission coefficient TD-SCDMA B39

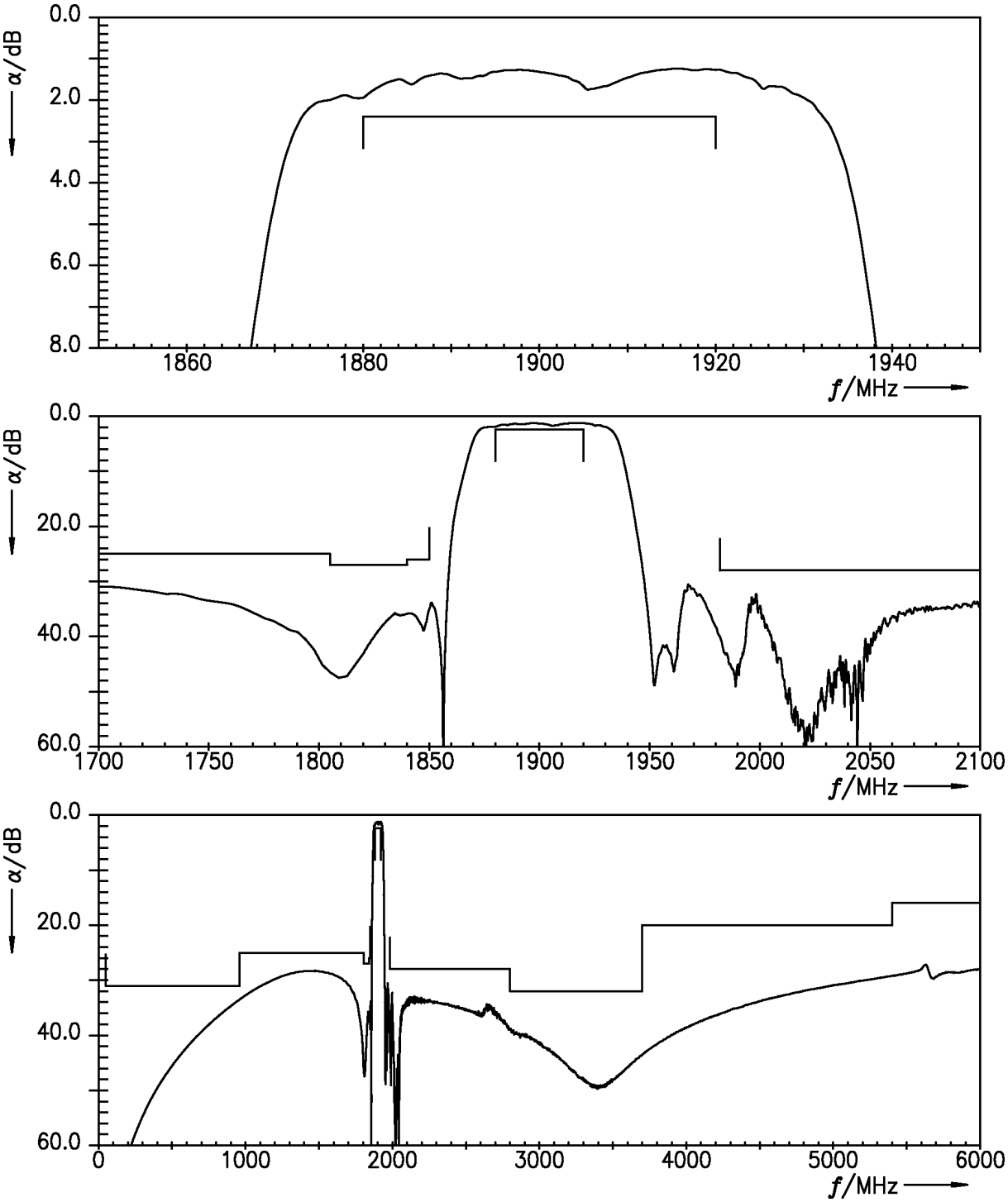

Figure 7: Attenuation TD-SCDMA B39.

12 Reflection coefficients TD-SCDMA B39

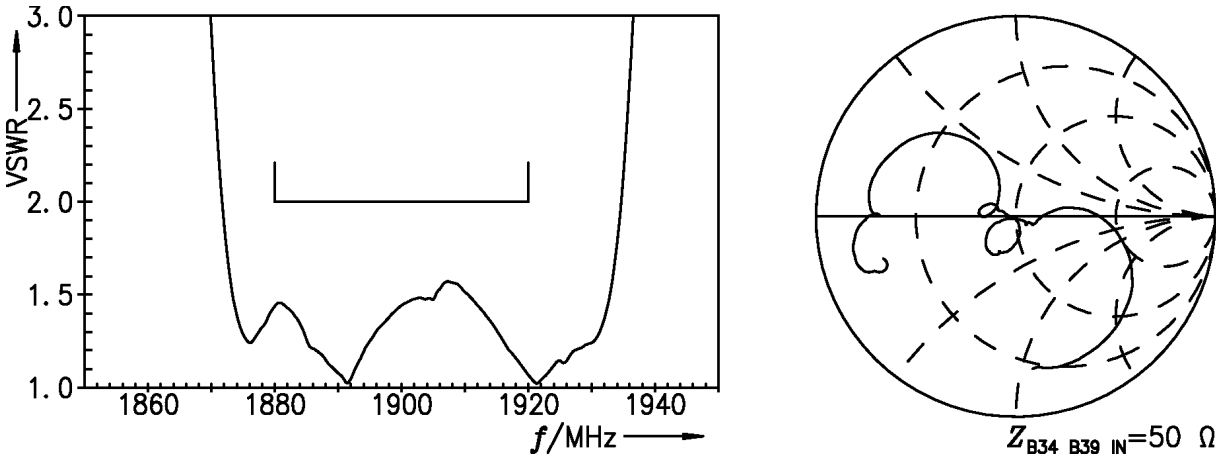

Figure 8: Reflection coefficient at input port.

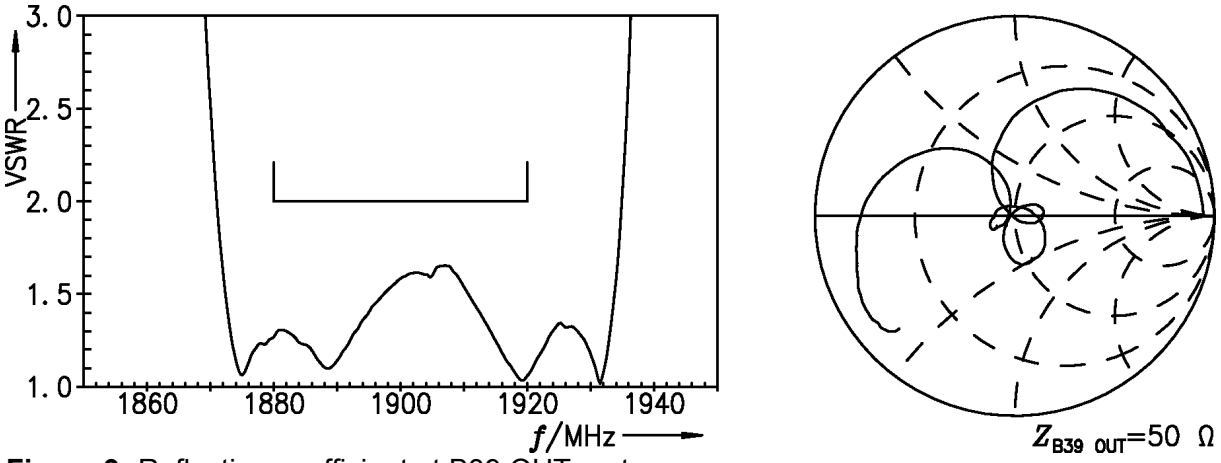

Figure 9: Reflection coefficient at B39 OUT port.

13 Packing material

13.1 Tape

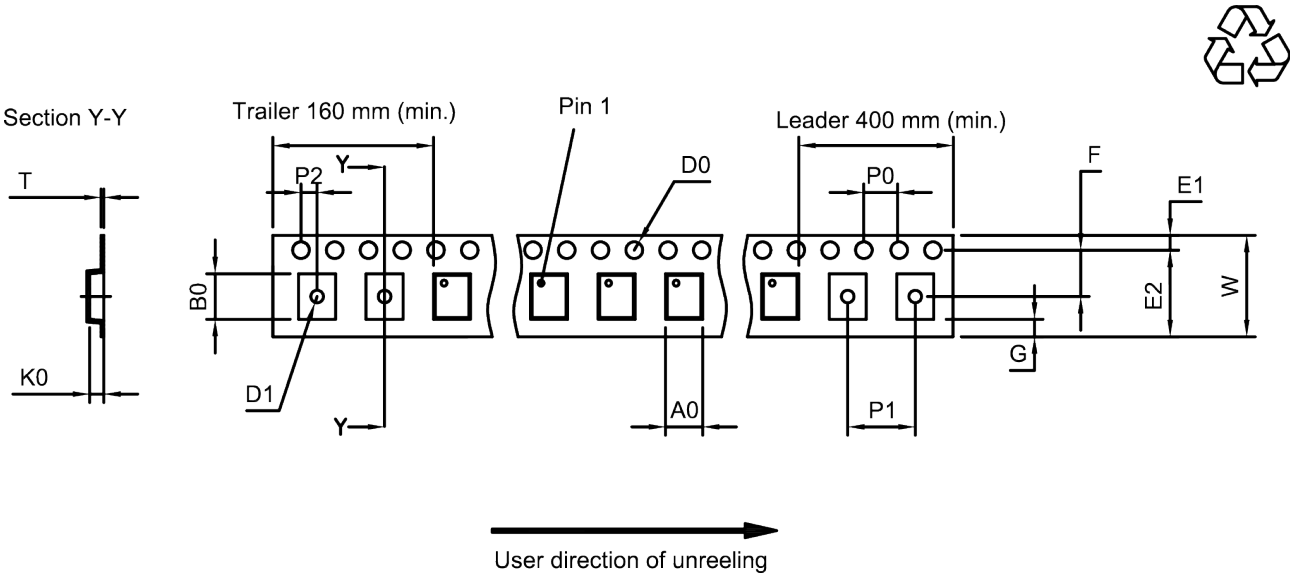

Figure 10: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A_0	1.27±0.05 mm
B_0	1.67±0.05 mm
D_0	1.5+0.1/−0 mm
D_1	0.5+0.1/−0 mm
E_1	1.75±0.1 mm

E_2	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K_0	0.55±0.05 mm
P_0	4.0±0.1 mm

P_1	4.0±0.1 mm
P_2	2.0±0.05 mm
T	0.25±0.03 mm
W	8.0+0.3/−0.1 mm

Table 1: Tape dimensions.

13.2 Reel with diameter of 180 mm

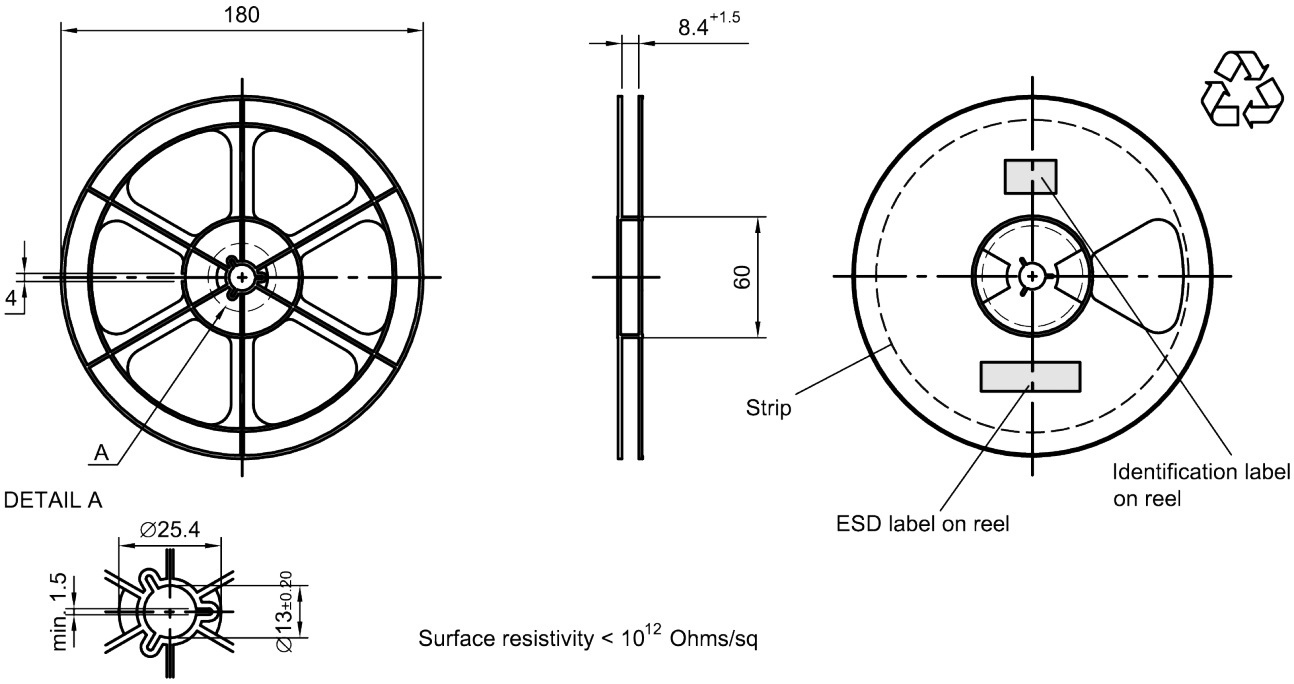

Figure 11: Drawing of reel (first-angle projection) with diameter of 180 mm.

Dimensions [mm]
X = 220+5
Y = 235+5
Sealing area 10±3

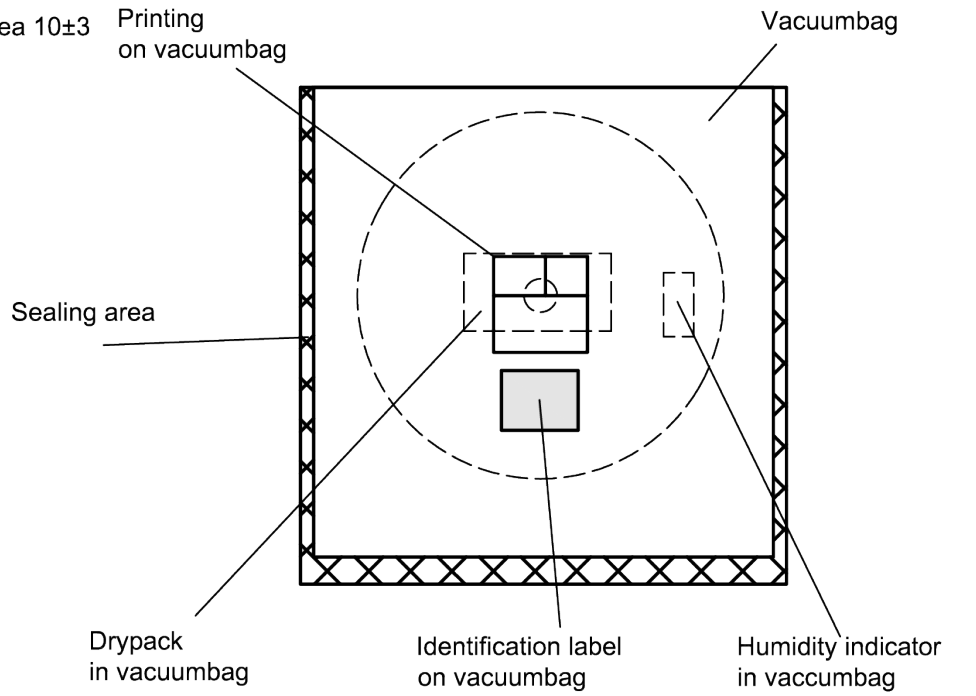

Figure 12: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

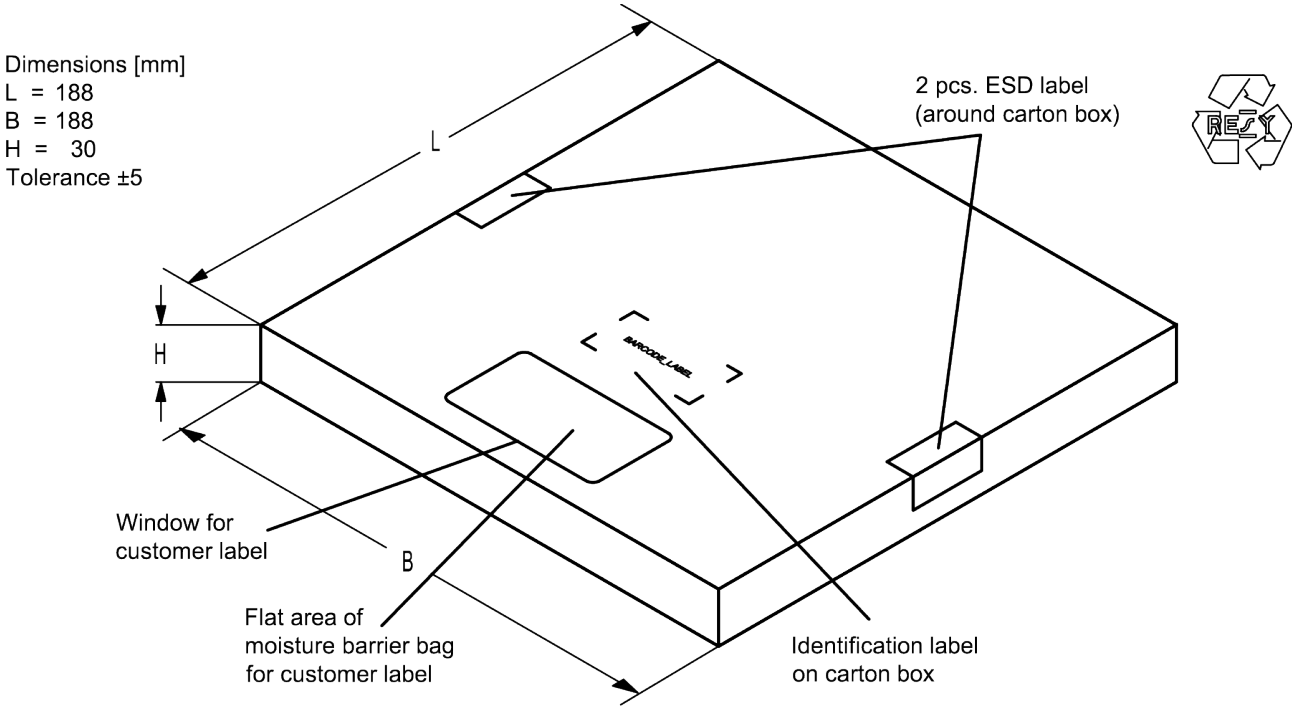

Figure 13: Drawing of folding box for reel with diameter of 180 mm.

14 Marking

Products are marked with product type number and lot number encoded according to Table 2:

- Type number:

  The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx,
  is encoded by a special BASE32 code into a 3 digit marking.

  Example of decoding type number marking on device in decimal code.
  16J **=>** **1234**
  1 x 32^2 + **6** x 32^1 + **18 (=J)** x 32^0 **=** **1234**
  The BASE32 code for product type B4384 is 490.

- Lot number:

  The last 5 digits of the lot number, e.g., **12345**,
  are encoded based on a special BASE47 code into a 3 digit marking.

  Example of decoding lot number marking on device in decimal code.
  5UY **=>** **12345**
  5 x 47^2 + **27 (=U)** x 47^1 + **31 (=Y)** x 47^0 **=** **12345**

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

Table 2: Lists for encoding and decoding of marking.

15 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

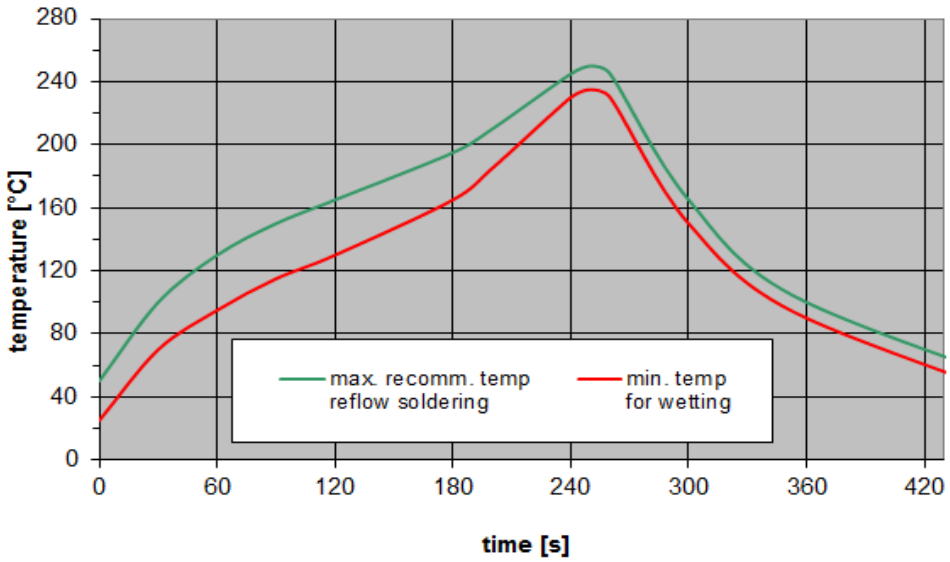

Figure 14: Recommended reflow profile for convection and infrared soldering – lead-free solder.

16 Annotations

16.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

16.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

17 Cautions and warnings

17.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under https://rffe.qualcomm.com/.

17.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

17.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

17.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.

18 Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (https://rffe.qualcomm.com). Should you have any more detailed questions, please contact our sales offices.
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